

PRESS RELEASE

BE Semiconductor Industries N.V. Announces 2023 First Quarter Conference Call and Webcast Details

Duiven, the Netherlands, April 19, 2023 - BE Semiconductor Industries N.V. ("the Company" or "Besi"), (Euronext Amsterdam: BESI; OTC: BESIY), a leading manufacturer of assembly equipment for the semiconductor industry, will release its results for the first quarter ended March 31, 2023, on Wednesday April 26, 2023 at 7.00 a.m. CET (1.00 a.m. EDT).

A conference call to discuss the Company's 2023 first quarter results will be held on Wednesday April 26, 2023, at 4.00 pm CET (10.00 am EDT).

Interested parties can pre-register using this <u>link</u> to receive the dial-in number and a personal PIN which are required to get access to the conference call. The audio webcast can be accessed via: <u>www.besi.com</u>, where also a replay will be available shortly after the call.

About Besi

Besi is a leading supplier of semiconductor assembly equipment for the global semiconductor and electronics industries offering high levels of accuracy, productivity and reliability at a low cost of ownership. The Company develops leading edge assembly processes and equipment for leadframe, substrate and wafer level packaging applications in a wide range of end-user markets including electronics, mobile internet, cloud server, computing, automotive, industrial, LED and solar energy. Customers are primarily leading semiconductor manufacturers, assembly subcontractors and electronics and industrial companies. Besi's ordinary shares are listed on Euronext Amsterdam (symbol: BESI). Its Level 1 ADRs are listed on the OTC markets (symbol: BESIY) and its headquarters are located in Duiven, the Netherlands. For more information, please visit our website at www.besi.com.

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